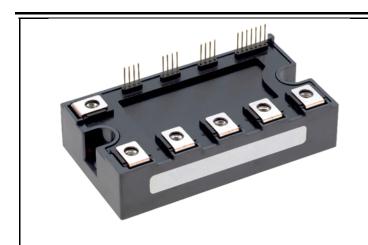


<Intelligent Power Modules>

# PM75CG1A065/PM75CG1AL065

FLAT-BASE TYPE INSULATED PACKAGE



#### **FEATURE**

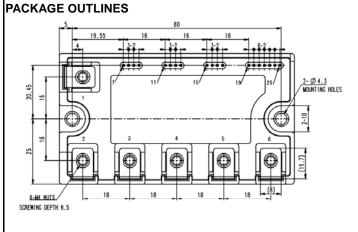
- a) Adopting Full-Gate CSTBT™ chip.
- b) The over-temperature protection which detects the chip surface temperature of CSTBT™ is adopted.
- c) Error output signal is available from each protection upper and lower arm of IPM.
- d) Outputting an error signal corresponding to the abnormal state (error mode identification)

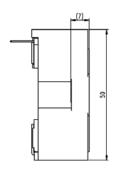
### UL Recognized under UL1557, File No. E323585

This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU.

#### **APPLICATION**

General purpose inverter, servo drives and other motor controls

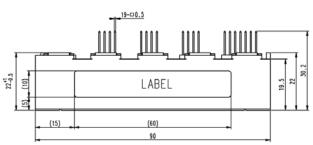


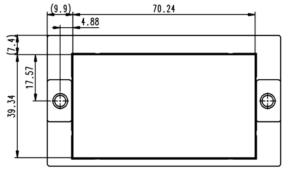


# Dimensions in mm

Tolerance otherwise specified

_	ivisio imen	Tolerance		
	0.5 to 3			±0.2
over	3	to	6	±0.3
over	6	to	30	±0.5
over	30	to '	120	±0.8
over 1	120	to 4	400	±1.2





#### **TERMINAL CODE**

----CG1A type----

1.NC, 2.P, 3.N, 4.U, 5.V, 6.W, 7.Vupc, 8.Ufo, 9.Up, 10.Vup1, 11.Vvpc, 12.Vfo, 13.Vp, 14.Vvp1, 15.Vwpc, 16.Wfo, 17.Wp, 18.Vwp1, 19.Vnc, 20.Vn1, 21.NC, 22.Un, 23.Vn, 24.Wn, 25.Fo

---CG1AL type----

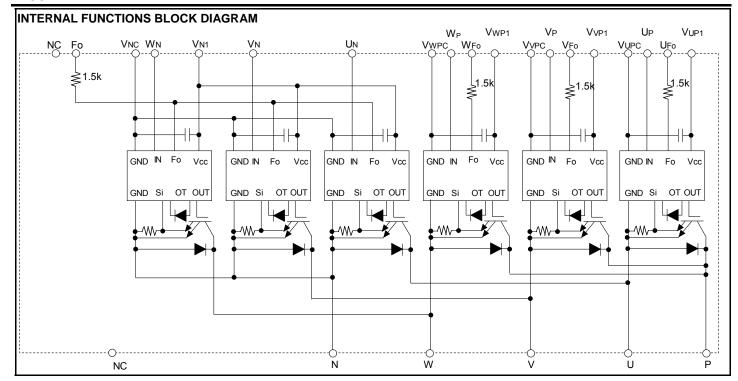
1.N, 2.P, 3.NC, 4.U, 5.V, 6.W, 7.V<sub>UPC</sub>, 8.U<sub>FO</sub>, 9.U<sub>P</sub>, 10.V<sub>UP1</sub>, 11.V<sub>VPC</sub>, 12.V<sub>FO</sub>, 13.V<sub>P</sub>, 14.V<sub>VP1</sub>, 15.V<sub>WPC</sub>, 16.W<sub>FO</sub>, 17.W<sub>P</sub>, 18.V<sub>WP1</sub>, 19.V<sub>NC</sub>, 20.V<sub>N1</sub>, 21.NC, 22.U<sub>N</sub>, 23.V<sub>N</sub>, 24.W<sub>N</sub>, 25.F<sub>O</sub>

1

Publication date: Nov, 2017

HIGH POWER SWITCHING USE

**INSULATED TYPE** 



## **MAXIMUM RATINGS** (Tvj = 25°C, unless otherwise noted)

#### **INVERTER PART**

Symbol	Parameter	Conditions	Ratings	Unit	
V <sub>CES</sub>	Collector-Emitter Voltage	V <sub>D</sub> =15 V, V <sub>CIN</sub> =15 V	650	V	
I <sub>C</sub>	Collegator Comment	T <sub>C</sub> =25 °C	75		
I <sub>CRM</sub>	Collector Current	Pulse	150	_ A	
P <sub>tot</sub>	Total Power Dissipation	T <sub>C</sub> =25 °C	297	W	
lE	Emitter Current	T <sub>C</sub> =25 °C	75	^	
I <sub>ERM</sub>	(Free-wheeling Diode Forward current)	Pulse	150	Α	
Tvj	Junction Temperature		-20 ~ +150	°C	

<sup>\*:</sup> Tc measurement point is just under the chip.

### **CONTROL PART**

Symbol	Parameter	Conditions	Ratings	Unit
$V_D$	Supply Voltage	Applied between: V <sub>UP1</sub> -V <sub>UPC</sub> , V <sub>VP1</sub> -V <sub>VPC</sub> , V <sub>WP1</sub> -V <sub>WPC</sub> , V <sub>N1</sub> -V <sub>NC</sub>	20	V
V <sub>CIN</sub>	Input Voltage	Applied between: U <sub>P</sub> -V <sub>UPC</sub> , V <sub>P</sub> -V <sub>VPC</sub> , W <sub>P</sub> -V <sub>WPC</sub> , U <sub>N</sub> , V <sub>N</sub> , W <sub>N</sub> -V <sub>NC</sub>	20	V
$V_{FO}$	Fault Output Supply Voltage	Applied between: U <sub>FO</sub> -V <sub>UPC</sub> , V <sub>FO</sub> -V <sub>VPC</sub> , W <sub>FO</sub> -V <sub>WPC</sub> , Fo-V <sub>NC</sub>	20	V
I <sub>FO</sub>	Fault Output Current	Sink current at U <sub>FO</sub> , V <sub>FO</sub> , W <sub>FO</sub> , Fo terminals	20	mA

#### **TOTAL SYSTEM**

Symbol	Parameter	Conditions	Ratings	Unit
V <sub>CC(PROT)</sub>	Supply Voltage Protected by SC	V <sub>D</sub> =13.5 V~16.5 V, Inverter Part, Tvj=+125°C start	400	V
T <sub>stg</sub>	Storage Temperature	-	-40 ~ +125	°C
Tc	Operating Case Temperature	-	-20 ~ +125	°C
V <sub>isol</sub>	Isolation Voltage	60Hz, Sinusoidal, Charged part to Base plate, AC 1min, RMS	2500	V

<sup>\*:</sup> Tc measurement point is just under the chip.

HIGH POWER SWITCHING USE

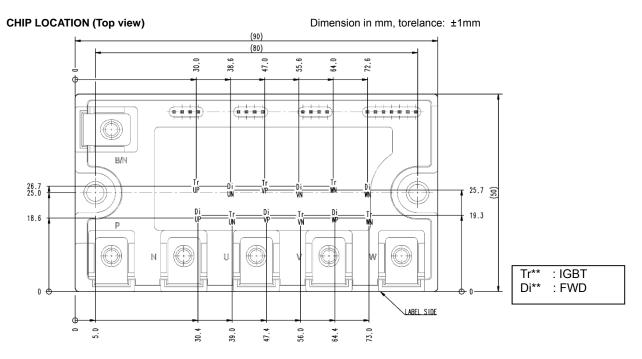
INSULATED TYPE

## THERMAL RESISTANCE

Symbol	Parameter	Conditions		Limits		
Syllibol	Faiailletei	Conditions	Min.	Тур.	Max.	Unit
$R_{th(j-c)Q}$	Thermal Resistance	Junction to case, IGBT, per 1 element (Note1)		-	0.42	K/W
$R_{th(j-c)D}$	mermai Resistance	Junction to case, FWD, per 1 element (Note1)	-	-	0.68	r/vv
D	Contact Thermal Resistance	Case to heat sink, per 1 module,	-	19.1	-	K/kW
$R_{th(c-s)}$		Thermal grease applied (Note.1, 2)				IVKVV

Note1. If you use this value,  $R_{\text{th(s-a)}}$  should be measured just under the chips.

Note2. Typical value is measured by using thermally conductive grease of  $\lambda$ =0.9W/(m·K),  $D_{(C-S)}$ =50  $\mu$ m.



## **ELECTRICAL CHARACTERISTICS** (Tvj= 25°C, unless otherwise noted)

### **INVERTER PART**

Symbol	Parameter	Conditions			Limits			Unit
Symbol	Farameter				Min.	Тур.	Max.	Offic
			T:-05 %C	Terminal	-	-	1.75	
	Collector-Emitter Saturation Voltage	$V_D = 15 \text{ V}, I_C = 75 \text{ A}$	Tvj=25 °C	Chip	-	1.25	-	V
V <sub>CEsat</sub>		V =0.V/ Dulood (Fig. 1)	Tui=125 °C	Terminal	-	-	2.0	V
		V <sub>CIN</sub> =0 V, Pulsed, (Fig.1)	Tvj=125 °C	Chip	-	1.33	-	
		V <sub>D</sub> =15 V, I <sub>E</sub> =75 A, Tvj=25 °C	Tvi=25 °C	Terminal	-	-	1.95	- V
$V_{EC}$	Emitter-Collector Voltage		1 Vj-25 C	Chip	1	1.40	1	
VEC		V <sub>CIN</sub> = 15 V, pulsed, (Fig.2) Tvj=125 °C	Tui=105 °C	Terminal	ı	-	2.05	
			1 Vj=125 C	Chip	ı	1.45	ı	
t <sub>on</sub>		$V_D=15 \text{ V}, V_{CIN}=0 \text{ V} \longleftrightarrow 15 \text{ V},$			0.3	0.6	1.2	
t <sub>rr</sub>		$V_{\rm CC}$ =300 V, $I_{\rm C}$ =75A, Tvj=125 °C, Inductive Load		-	0.2	0.65		
t <sub>c(on)</sub>	Switching Time				-	0.17	0.75	μs
t <sub>off</sub>					-	1.0	2.3	
t <sub>c(off)</sub>		(Fig.3, 4)			-	0.13	0.4	
	Callantan Fraittan Cut off Current	V <sub>CE</sub> =V <sub>CES</sub> , V <sub>D</sub> =15 V,		Tvj=25 °C	-	-	1	A
I <sub>CES</sub>		V <sub>CIN</sub> =15 V (Fig.5)		Tvj=125 °C	ı	-	10	mA

HIGH POWER SWITCHING USE

INSULATED TYPE

## **ELECTRICAL CHARACTERISTICS** (Tvj = 25°C, unless otherwise noted)

#### **CONTROL PART**

Cumbal	Parameter	Conditions		Limits			Unit
Symbol	Parameter	Conditions	Conditions			Max.	Offic
		V <sub>D</sub> =15 V. V <sub>CIN</sub> =15 V	V <sub>P1</sub> -V <sub>PC</sub>	-	4	6	
	Circuit Commant	V <sub>D</sub> =15 V, V <sub>CIN</sub> =15 V	V <sub>N1</sub> -V <sub>NC</sub>	-	12	18	
I <sub>D</sub>	Circuit Current	V <sub>D</sub> =15 V, V <sub>CIN</sub> =0 V←15 V, V <sub>CC</sub> =400 V	V <sub>P1</sub> -V <sub>PC</sub>	-	12	15	mA
		I <sub>C</sub> =0A, Tvj=125 °C, f <sub>C</sub> ≤20kHz	V <sub>N1</sub> -V <sub>NC</sub>	-	36	44	
$V_{th(ON)}$	Input ON Threshold Voltage	Applied between:		1.2	1.5	1.8	.,
$V_{th(OFF)}$	Input OFF Threshold Voltage	$U_{P}$ - $V_{UPC}$ , $V_{P}$ - $V_{VPC}$ , $W_{P}$ - $V_{WPC}$ , $U_{N}$ , $V_{N}$ , $W_{N}$ - $V_{N}$	$U_{P}$ - $V_{UPC}$ , $V_{P}$ - $V_{VPC}$ , $W_{P}$ - $V_{WPC}$ , $U_{N}$ , $V_{N}$ , $W_{N}$ - $V_{NC}$		2.0	2.3	V
SC	Short Circuit Trip Level	-20≤Tvj≤125 °C, V <sub>D</sub> =15 V (Fig.3, 6)		150	-	-	Α
t <sub>d(SC)</sub>	Short Circuit Current Delay Time	V <sub>D</sub> =15 V, Tvj=125 °C (Fig.3, 6)		-	2.0	-	μs
ОТ	Over Terror and an Protection	Detect temperature of IGBT chip surface	Trip level	150	-	-	°C
OT <sub>(hys)</sub>	Over Temperature Protection		Hysteresis	-	20	-	
UV <sub>t</sub>	Supply Circuit		Trip level	11.0	12.0	12.7	V
UV <sub>r</sub>	Under-Voltage Protection	-	Reset level	-	12.5	-	V
I <sub>FO(H)</sub>	Fault Outrout Ourseart	V =45 V V =45 V (No+2)		-	-	0.01	A
I <sub>FO(L)</sub>	Fault Output Current	V <sub>D</sub> =15 V, V <sub>FO</sub> =15 V (Note3)		-	10	15	mA
			ОТ		8.0	-	ms
t <sub>FO</sub>	Fault Output Pulse Width	V <sub>D</sub> =15 V (Note3)	UV	-	4.0	-	
			SC	-	2.0	-	

Note3. Fault output is given only when the internal SC, OT & UV protections schemes of either upper or lower arm device operate to protect it.

#### **MECHANICAL RATINGS AND CHARACTERISTICS**

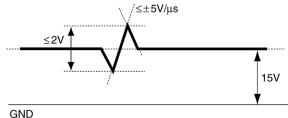
Symbol	Parameter	Conditions	Limits			Unit
Syllibol	Falailletei	Conditions	Min.	Тур.	Max.	OTIIL
Ms	Mounting Torque	Mounting part screw : M4	1.5	1.7	2.0	N•m
$M_t$	Mounting Torque	Main terminal part screw : M4	1.5	1.7	2.0	INTIL
m	mass	-	-	175	1	g

### **RECOMMENDED CONDITIONS FOR USE**

Symbol	Parameter	Conditions	Recommended value	Unit
Vcc	Supply Voltage	Applied across P-N terminals	≤ 400	V
V <sub>D</sub>	Control Supply Voltage	Applied between:  VUP1-VUPC, VVP1-VVPC, VWP1-VWPC, VN1-VNC (Note4)	15.0±1.5	٧
V <sub>CIN(ON)</sub>	Input ON Voltage	Applied between:	≤ 0.8	V
V <sub>CIN(OFF)</sub>	Input OFF Voltage	$U_P$ - $V_{UPC}$ , $V_P$ - $V_{VPC}$ , $W_P$ - $V_{WPC}$ , $U_N$ , $V_N$ , $W_N$ - $V_{NC}$	≥ 9.0	V
f <sub>PWM</sub>	PWM Input Frequency	Using Application Circuit of Fig. 8	≤ 20	kHz
t <sub>dead</sub>	Arm Shoot-through Blocking Time	For IPM's each input signals (Fig.7)	≥ 2.0	μs

This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU.

Note4. With ripple satisfying the following conditions: dv/dt swing  $\leq \pm 5$   $V/\mu s$ ,  $Variation \leq 2$  V peak to peak



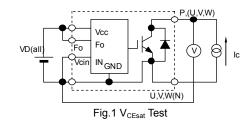
HIGH POWER SWITCHING USE

**INSULATED TYPE** 

#### PRECAUTIONS FOR TESTING

- 1. Before applying any control supply voltage (V<sub>D</sub>), the input terminals should be pulled up by resistors, etc. to their corresponding supply voltage and each input signal should be kept off state.
  - After this, the specified ON and OFF level setting for each input signal should be done.
- 2. When performing "SC" tests, the turn-off surge voltage spike at the corresponding protection operation should not be allowed to rise above V<sub>CES</sub> rating of the device.

(These test should not be done by using a curve tracer or its equivalent.)



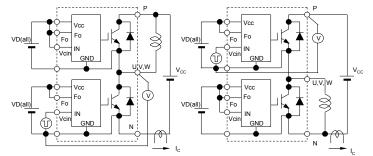
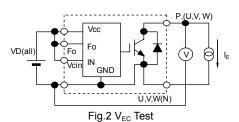


Fig.3 Switching time and SC test circuit



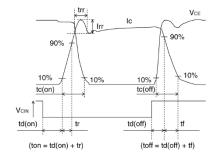


Fig.4 Switching time test waveform

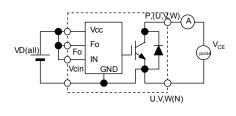


Fig.5 I<sub>CES</sub> Test

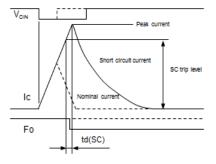
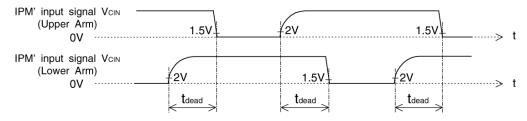


Fig.6 SC test waveform

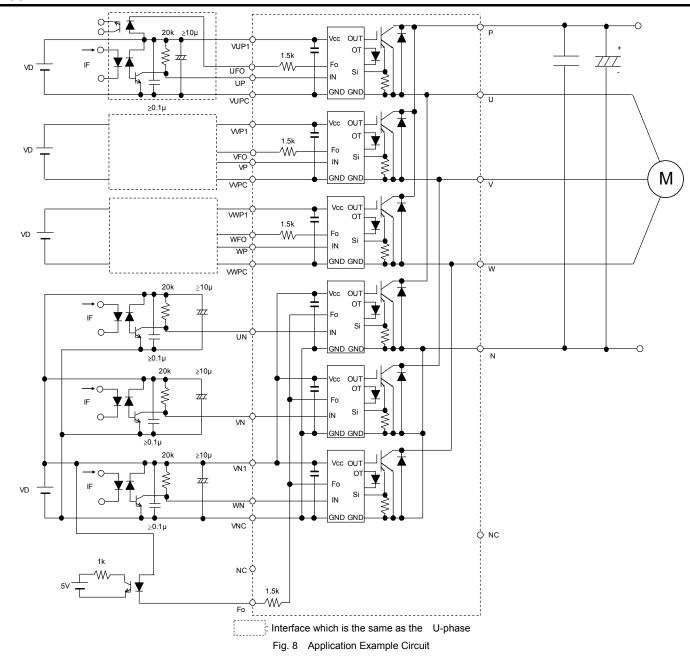


1.5V: Input on threshold voltage Vth(on) typical value, 2V: Input off threshold voltage Vth(off) typical value

Fig. 7 Dead time measurement point example

HIGH POWER SWITCHING USE

**INSULATED TYPE** 

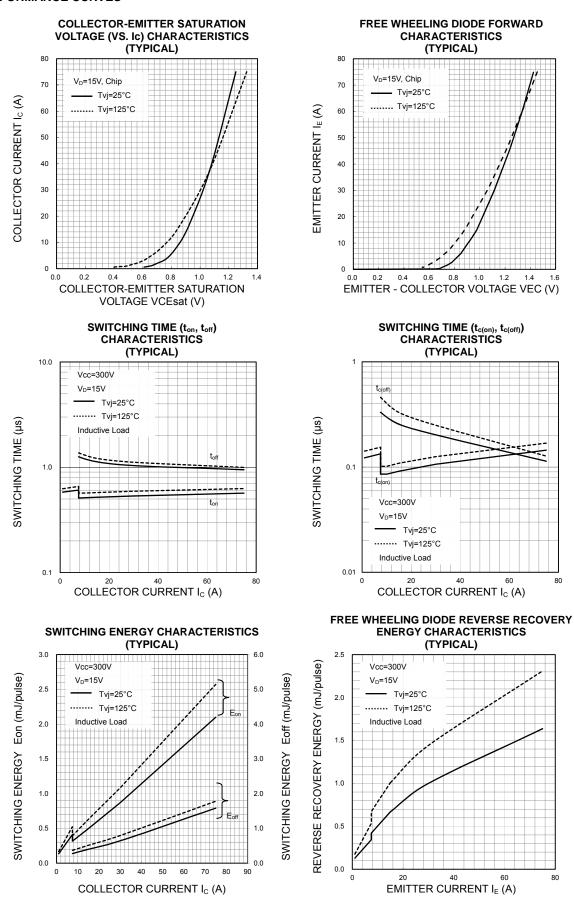


#### NOTES FOR STABLE AND SAFE OPERATION;

- Design the PCB pattern to minimize wiring length between opto-coupler and IPM's input terminal, and also to minimize the stray capacity between the input and output wirings of opto-coupler.
- Connect low impedance capacitor between the Vcc and GND terminal of each fast switching opto-coupler.
- Fast switching opto-couplers:  $t_{PLH}$ ,  $t_{PHL} \le 0.8 \mu s$ , Use High CMR type.
- Slow switching opto-coupler: CTR > 100%
- $\bullet \ \ \text{Use 4 isolated control power supplies ($V_D$)}. \ Also, care should be taken to minimize the instantaneous voltage charge of the power supply.$
- Make inductance of DC bus line as small as possible, and minimize surge voltage using snubber capacitor between P and N terminal.

**INSULATED TYPE** 

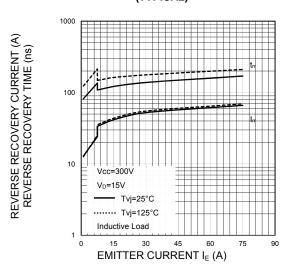
#### PERFORMANCE CURVES



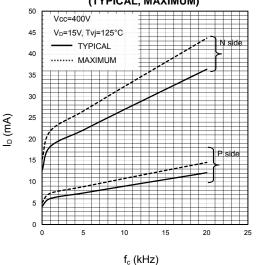
HIGH POWER SWITCHING USE

INSULATED TYPE

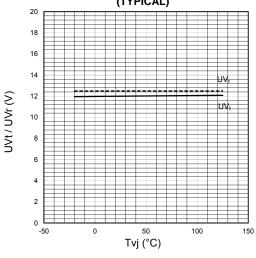
#### FREE WHEELING DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



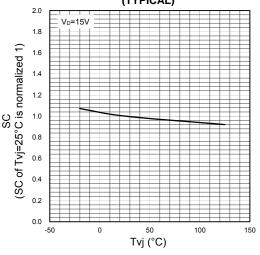
# I<sub>D</sub> VS. f<sub>C</sub> CHARACTERISTICS (TYPICAL, MAXIMUM)



# UV TRIP LEVEL VS. Tvj CHARACTERISTICS (TYPICAL)



# SC TRIP LEVEL VS. Tvj CHARACTERISTICS (TYPICAL)



#### TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (TYPICAL)

ш	i	1	2	3	4
Ō	Ri	0.0124	0.0739	0.3505	0.5632
\{\bar{\chi}	ті (sec)	1.961E-05	0.0014	0.0179	0.0944
NORMARIZED TRANSIENT THERMAL IMPEDANCE Zth(j-c)	10				
Σ					
_					
Ž					
H	1				
Εç					
F :-					
百計	0.1				
SZ	0.1				
<u></u>					
Ħ	0.01		e Pulse		
R			T Part; unit base: R	th(i-c)O=0.4	ok w
₹		FW	D Part;		
Ŗ		Per	unit base: R	th(j-c)D=0.6	8K /W
$\geq$	0.001				
	0.00001	0.0001 0.0		0.1	1 10
			TIME (s)		

HIGH POWER SWITCHING USE INSULATED TYPE

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